

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S49	196	(yewebdar or tadesse) and "118"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/29 08:28
S50	9	(yewebdar or tadesse) and "264"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/25 14:23
S55	81	nguyen-andrew\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 15:23
S56	49	S55 and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 15:47
S57	27	S55 and nozzle	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 15:47
S58	14	S57 and (valve\$1 and pump\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 15:31
S59	24	S57 and (valve\$1 or pump\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 15:31
S60	13	S55 and head	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 15:47

S61	5	S55 and developer near3 module	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:09
S62	1	("5866709").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/13 16:09
S63	1	("5866307").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/13 16:14
S64	1400	(118/52,612).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 15:46
S65	6	(("6432199") or ("5705223") or ("5947136") or ("5762709") or ("6533864") or ("5940651")).PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 15:43
S73	18	Yoshihara and S64	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:25
S74	26	matsuyama and S64	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:21
S75	1	("5962070").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/13 16:26
S76	1	("5405443").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/13 16:26
S79	3	"2003101929"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:31
S80	2	"2003183250"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:31

S81	2	"20040222323"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:33
S82	2	"20030183250"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:31
S83	2	"20030101929"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:32
S84	4	S64 and (nozzle\$1 near5 drain\$3 near5 (valv\$3 or pump\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 15:59
S85	7	S64 and (nozzle\$1 near5 drain\$3) same (valv\$3 or pump\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:51
S86	43	S64 and drain\$3 near5 valve\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:52
S87	17	S64 and drain\$3 near5 valve\$1 same nozzle\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:56
S88	620	(396/611,627).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/13 16:56
S89	8	S88 and drain\$3 near5 valve\$1 same nozzle\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/13 16:56

S90	4	("5759614" "5854953" "5965200" "6092937").PN. OR ("6692165").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/13 16:57
S91	1	("4670247").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/14 10:10
S92	1	10/743928	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 09:16
S93	2	10/090099	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 09:17
S94	0	S93 and frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 09:17
S95	2	"20020053319"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 15:45
S98	1402	(118/52,612).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 15:49
S99	86	S98 and (nozzle\$1 near5 (outlet\$1 or drain\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 15:49
S100	4	("5759614" "5854953" "5965200" "6092937").PN. OR ("6692165").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 15:57
S101	35	S98 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:13

S10 2	88	nozzle\$1 near5 outlet\$1 near5 inlet\$1 near5 drain\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:07
S10 3	620	(396/611,627).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 16:13
S10 4	10	S103 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:49
S10 5	10	etching near3 wafer and nozzle\$1 near3 drain\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:49
S10 6	170	(134/88,91).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 16:49
S10 9	20	S106 and (nozzle\$1 same drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:54
S11 0	487	"134"/\$.ccls. and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 17:13
S11 1	85	"134"/\$.ccls. and (nozzle\$1 near5 drain\$3) and (wafer\$1 or semiconductor\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:53
S11 2	741	(134/198).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 16:54
S11 3	102	S112 and (nozzle\$1 same drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 16:54

S11 5	1141	(134/153).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/15 17:13
S11 6	31	S115 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/16 10:33
S11 7	1	10/367719	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/15 17:30
S11 8	943	(118/300).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/16 10:33
S11 9	9	S118 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/19 08:02
S12 0	366	(118/305).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/16 10:33
S12 1	2	S120 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/16 10:38
S12 2	218	(396/634,635).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/16 10:38
S12 3	0	S122 and ((nozzle\$1 or head\$1 or applicator\$1) near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/16 10:39
S12 4	14	S118 and ((nozzle\$1 or head\$1 or applicator\$1) near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/16 10:40
S12 5	1402	(118/52,612).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/16 10:40

S12 6	40	S125 and ((nozzle\$1 or head\$1 or applicator\$1) near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/16 10:42
S12 7	620	(396/611,627).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/16 10:41
S12 8	11	S127 and ((nozzle\$1 or head\$1 or applicator\$1) near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/16 10:41
S12 9	1141	(134/153).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/16 10:41
S13 0	40	S129 and ((nozzle\$1 or head\$1 or applicator\$1) near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/16 10:41
S13 1	3	("5769956").URPN.	USPAT	OR	OFF	2005/12/19 08:01
S13 2	1141	(134/153).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/19 08:02
S13 3	31	S132 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/19 08:26
S13 4	1039	(222/478).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/19 08:26
S13 5	1	S134 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/19 08:28
S13 6	577	(239/104,106).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/19 08:28

S13 7	6	S136 and (nozzle\$1 near5 drain\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 08:59
S13 8	1	("5962070").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 16:50
S13 9	21	("5427820" "5571560" "5695817").PN. OR ("5962070").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 16:50
S14 0	8	S139 and drain\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 17:16
S14 1	1	S138 and drain\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 16:52
S14 2	954	drain\$3 near5 bubble\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 16:52
S14 3	11	nozzle\$1 near5 drain\$3 near5 bubbl\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 16:57
S14 4	1403	(118/52,612).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 16:57
S14 5	4	S144 and nozzle\$1 same drain\$3 same bubbl\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 17:36
S14 6	4	wafer\$1 and nozzle\$1 near5 drain\$3 near5 bubbl\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 17:02
S14 7	3	("4326553" "5927306").PN. OR ("6223996").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 17:15
S14 8	0	S147 and drain\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/20 17:16
S14 9	35	S144 and nozzle\$1 near5 drain\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/21 08:57
S15 0	741	(134/198).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/21 08:58
S15 1	1824	(134/902).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/21 08:58

S15 4	1403	(118/52,612).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/21 09:00
S15 6	577	(239/104,106).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/21 09:00
S15 7	1039	(222/478).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/21 09:00
S15 8	1141	(134/153).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/21 09:00
S16 1	2	S157 and ((nozzle\$1 or applicator\$1 or head\$1 or spray\$3) near5 (drain\$3 or purg\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:04
S16 6	60	S154 and ((nozzle\$1 or applicator\$1 or head\$1 or spray\$3) near5 (drain\$3 or purg\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:09
S16 7	42	S150 and ((nozzle\$1 or applicator\$1 or head\$1 or spray\$3) near5 (drain\$3 or purg\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:31
S16 8	113	S151 and ((nozzle\$1 or applicator\$1 or head\$1 or spray\$3) near5 (drain\$3 or purg\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:10
S16 9	36	S156 and ((nozzle\$1 or applicator\$1 or head\$1 or spray\$3) near5 (drain\$3 or purg\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:04
S17 0	88	S158 and ((nozzle\$1 or applicator\$1 or head\$1 or spray\$3) near5 (drain\$3 or purg\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:04

S17 1	119	((nozzle\$1 or applicator\$1 or head\$1 or sprayer\$1) near5 (drain\$3 or purg\$3)) near5 drip\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:35
S17 2	180	((nozzle\$1 or applicator\$1 or head\$1 or sprayer\$1) near5 (drain\$3 or purg\$3)) near5 bubbl\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:36
S17 3	9	S172 and semiconductor\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:39
S17 4	9	S172 and wafer\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/21 09:39